

Low Noise, Fast Transient IA Step-Down Converter

General Description

The AAT2148 SwitchReg is a 2MHz step-down converter with an input voltage range of 2.7V to 5.5V and output voltage as low as 0.6V. It is optimized to react quickly to a load variation. The AAT2148 incorporates a unique low noise architecture which reduces ripple and spectral noise.

The AAT2148 is available in fixed voltage versions with internal feedback and a programmable version with external feedback resistors. It can deliver 1A of load current while maintaining a low $37\mu A$ no load quiescent current. The 2MHz switching frequency minimizes the size of external components while keeping switching losses low.

The AAT2148 is designed to maintain high efficiency throughout the operating range, which is critical for portable applications.

The AAT2148 is available in the Pb-free, thermally enhanced 3x3mm QFN-16 package and is rated over the -40°C to +85°C temperature range.

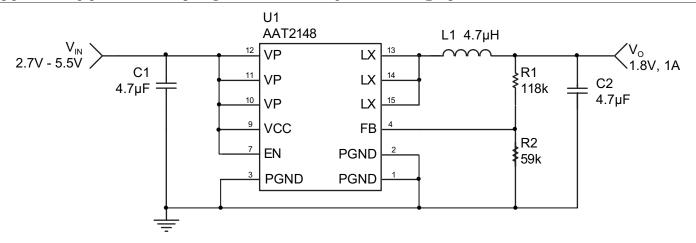
Features

- V_{IN} Range: 2.7V to 5.5V
- Low Noise Light Load Mode
- Low Ripple PWM Mode
- V_{OUT} Fixed or Adjustable from 0.6V to V_{IN}
- 37µA No Load Quiescent Current
- Up to 98% Efficiency
- 1A Max Output Current
- 2MHz Switching Frequency
- 150µs Soft Start
- Fast Load Transient
- Over-Temperature Protection
- Current Limit Protection
- 100% Duty Cycle Low-Dropout Operation
- <1µA Shutdown Current
- QFN33-16 Package
- Temperature Range: -40°C to +85°C

Applications

- · Cellular Phones
- Digital Cameras
- Handheld Instruments
- Microprocessor / DSP Core / IO Power
- PDAs and Handheld Computers
- USB Devices

Typical Application (Adjustable Output Voltage)





SwitchReg[™]

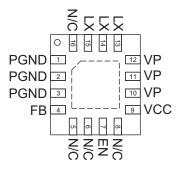
Low Noise, Fast Transient IA Step-Down Converter

Pin Descriptions

Pin #	Symbol	Function
1, 2, 3	PGND	Power ground pin
4	FB Feedback input. This pin is connected either directly to the converter output or to an external residue divider for an adjustable output.	
5, 6, 8, 16	N/C	Not internally connected.
9	VCC Bias supply. Supplies power for the internal circuitry. Connect to input power.	
10, 11, 12	11, 12 VP Input supply voltage for the converter power stage. Must be closely decoupled to GND.	
Switching node. Connect the inductor to this pin. It is internally connected to the drain of light and low-side MOSFETs.		Switching node. Connect the inductor to this pin. It is internally connected to the drain of both high- and low-side MOSFETs.
EP		Exposed paddle (bottom); connect to PGND directly beneath package.

Pin Configuration

QFN33-16 (Top View)





Low Noise, Fast Transient IA Step-Down Converter

Absolute Maximum Ratings¹

Symbol	Description	Value	Units
V_{IN}	Input Voltage GND	6.0	V
V_{LX}	LX to GND	-0.3 to V _{IN} + 0.3	V
V _{OUT}	OUT to GND	-0.3 to V _{IN} + 0.3	V
V_{EN}	EN to GND	-0.3 to V _{IN} + 0.3	V
T ₃	T ₁ Operating Junction Temperature Range		°C
T _{LEAD}	Maximum Soldering Temperature (at leads, 10 sec)	300	°C

Thermal Information

Symbol	Description	Value	Units
P_{D}	Maximum Power Dissipation ^{2, 3}	2	W
θ_{JA}	Thermal Resistance ²	50	°C/W

^{1.} Stresses above those listed in Absolute Maximum Ratings may cause permanent damage to the device. Functional operation at conditions other than the operating conditions specified is not implied. Only one Absolute Maximum Rating should be applied at any one time.

^{2.} Mounted on an FR4 board.

^{3.} Derate 6.25mW/°C above 25°C.



Low Noise, Fast Transient IA Step-Down Converter

Electrical Characteristics¹

 T_A = -40°C to +85°C, unless otherwise noted. Typical values are T_A = 25°C, V_{IN} = 3.6V.

Symbol	Description	Conditions	Min	Тур	Max	Units
Step-Dow	n Converter	<u>'</u>	'			
V _{IN}	Input Voltage		2.7		5.5	V
\/	UVLO Threshold	V _{IN} Rising		1.8	2.7	V
V_{UVLO}	OVLO TITESTICIO	Hysteresis		100		mV
V _{OUT}	Output Voltage Tolerance	$I_{OUT} = 0$ mA to 1A, $V_{IN} = 2.7$ V to 5.5V	-3.0		+3.0	%
V _{OUT}	Output Voltage Range		0.6		V_{IN}	V
I_Q	Quiescent Current	No Load, 0.6V Adjustable Version		37	70	μΑ
I_{SHDN}	Shutdown Current	EN = AGND = PGND			1.0	μΑ
I_{LIM}	P-Channel Current Limit		1300	1700		mA
R _{DS(ON)H}	High Side Switch On Resistance			0.35		Ω
R _{DS(ON)L}	Low Side Switch On Resistance			0.30		Ω
$\Delta V_{Linereg}$	Line Regulation	$V_{IN} = 2.7V \text{ to } 5.5V; I_{OUT} = 1A$		0.1		%/V
V_{FB}	Feedback Threshold Voltage Accuracy	0.6V Output, No Load; T _A = 25°C	591	600	609	mV
I_{FB}	Feedback Leakage Current	0.6V Output			1	μΑ
Ts	Start-Up Time	From Enable to Output Regulation		150		μs
Fosc	Oscillator Frequency	$T_A = 25$ °C	0.9	2.0	2.6	MHz
T_{SD}	Over-Temperature Shutdown Threshold			140		°C
T _{HYS}	Over-Temperature Shutdown Hysteresis			15		°C
N						
$V_{EN(L)}$	Enable Threshold Low				0.6	V
V _{EN(H)}	Enable Threshold High		1.4			V
$I_{\sf FN}$	Input Low Current	$V_{IN} = V_{OUT} = 5.5V$	-1.0		1.0	μΑ

^{1.} The AAT2148 is guaranteed to meet performance specifications over the -40°C to +85°C operating temperature range and is assured by design, characterization, and correlation with statistical process controls.

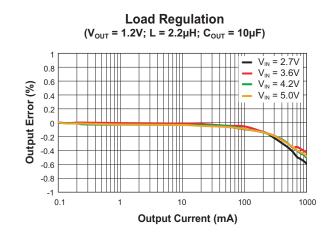


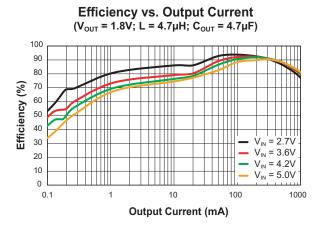
Low Noise, Fast Transient IA Step-Down Converter

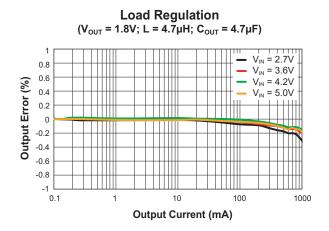
Typical Characteristics

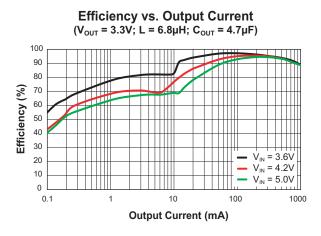
Efficiency vs. Output Current $(V_{OUT} = 1.2V; L = 2.2\mu H; C_{OUT} = 10\mu F)$ 100 90 80 70 Efficiency (%) 60 50 40 30 $V_{IN} = 3.6V$ 20 10 $V_{IN} = 5.0V$ n 1000 0.1

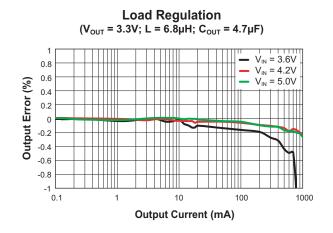
Output Current (mA)







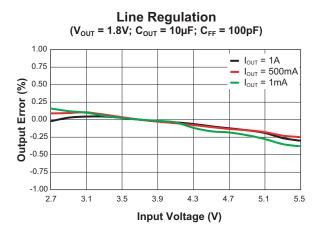




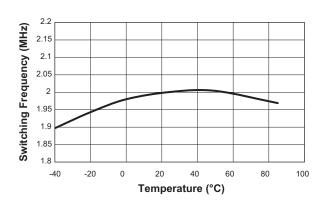


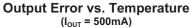
Low Noise, Fast Transient IA Step-Down Converter

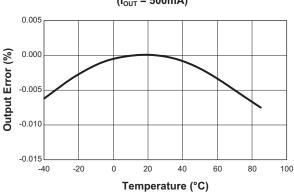
Typical Characteristics



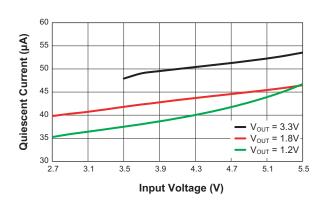
Switching Frequency vs. Temperature



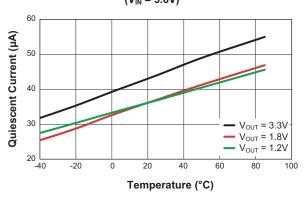




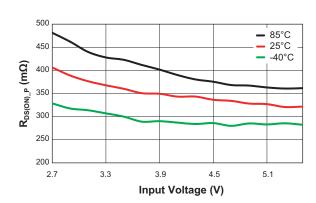
Quiescent Current vs. Input Voltage



Quiescent Current vs. Temperature (V_{IN} = 3.6V)



P-Channel $R_{\text{DS(ON)}}$ vs. Input Voltage

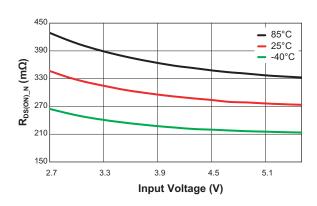


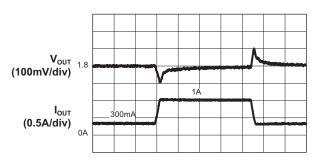


Low Noise, Fast Transient IA Step-Down Converter

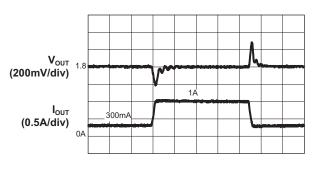
Typical Characteristics

N-Channel R_{DS(ON)} vs. Input Voltage

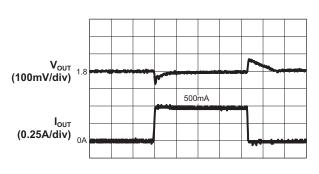




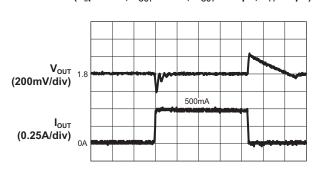
Time (16µs/div)



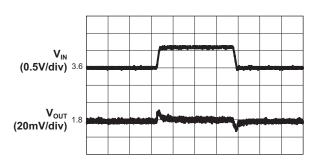
Time (16µs/div)



Time (40µs/div)



Time (40µs/div)

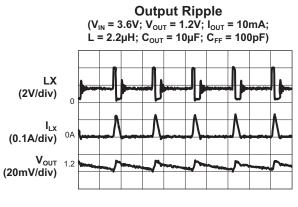


Time (200µs/div)

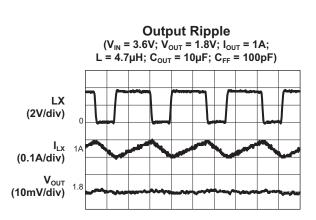


Low Noise, Fast Transient IA Step-Down Converter

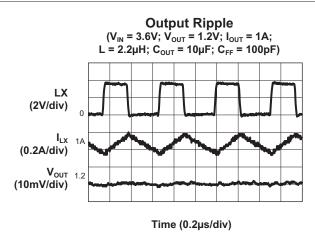
Typical Characteristics



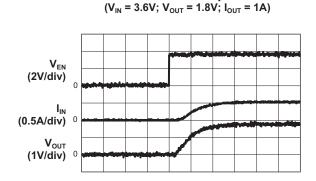
Time (1µs/div)



Time (0.2µs/div)



Soft Startup

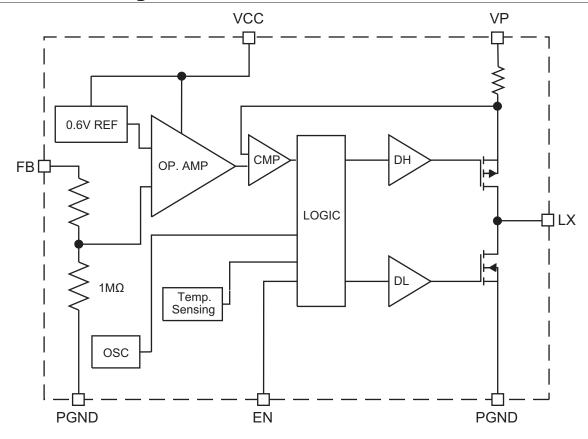


Time (100µs/div)



Low Noise, Fast Transient IA Step-Down Converter

Functional Block Diagram



Functional Description

The AAT2148 is a high performance 1A 2MHz monolithic step-down converter. It has been designed with the goal of minimizing external component size and optimizing efficiency over the complete load range, and produces reduced ripple and spectral noise. Apart from the small bypass input capacitor, only a small L-C filter is required at the output. Typically, a $4.7\mu H$ inductor and a $4.7\mu F$ ceramic capacitor are recommended (see table of values).

The fixed output version requires only three external power components (C_{IN} , C_{OUT} , and L). The adjustable version can be programmed with external feedback to any voltage, ranging from 0.6V to the input voltage. An additional feed-forward capacitor can also be added to the external feedback to provide improved transient response (see Figure 1).

At dropout, the converter duty cycle increases to 100% and the output voltage tracks the input voltage minus the R_{DSON} drop of the P-channel high-side MOSFET.

The input voltage range is 2.7V to 5.5V. The converter efficiency has been optimized for all load conditions, ranging from no load to 1A.

The internal error amplifier and compensation provides excellent transient response, load, and line regulation. Soft start eliminates any output voltage overshoot and input inrush current when the enable or the input voltage is applied.

Control Loop

The AAT2148 is a peak current mode step-down converter. The current through the P-channel MOSFET (high side) is sensed for current loop control, as well as short circuit and overload protection. A fixed slope compensation signal is added to the sensed current to maintain stability for duty cycles greater than 50%. The peak current mode loop appears as a voltage-programmed current source in parallel with the output capacitor.



Low Noise, Fast Transient IA Step-Down Converter

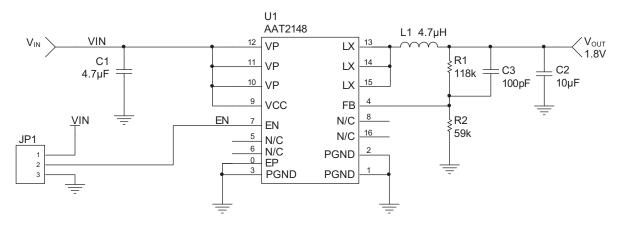


Figure 1: Enhanced Transient Response Schematic.

The output of the voltage error amplifier programs the current mode loop for the necessary peak switch current to force a constant output voltage for all load and line conditions. Internal loop compensation terminates the transconductance voltage error amplifier output. For fixed voltage versions, the error amplifier reference voltage is internally set to program the converter output voltage. For the adjustable output, the error amplifier reference is fixed at 0.6V.

Soft Start / Enable

Soft start limits the current surge seen at the input and eliminates output voltage overshoot. When pulled low, the enable input forces the AAT2148 into a low-power, non-switching state. The total input current during shutdown is less than 1μ A.

Current Limit and Over-Temperature Protection

For overload conditions, the peak input current is limited. To minimize power dissipation and stresses under current limit and short-circuit conditions, switching is terminated after entering current limit for a series of pulses. Switching is terminated for seven consecutive clock cycles after a current limit has been sensed for a series of four consecutive clock cycles.

Thermal protection completely disables switching when internal dissipation becomes excessive. The junction over-temperature threshold is 140°C with 15°C of hysteresis. Once an over-temperature or over-current fault conditions is removed, the output voltage automatically recovers.

Under-Voltage Lockout

Internal bias of all circuits is controlled via the V_{IN} input. Under-voltage lockout (UVLO) guarantees sufficient V_{IN} bias and proper operation of all internal circuitry prior to activation.



Low Noise, Fast Transient 1A Step-Down Converter

Applications Information

Inductor Selection

The step-down converter uses peak current mode control with slope compensation to maintain stability for duty cycles greater than 50%. The output inductor value must be selected so the inductor current down slope meets the internal slope compensation requirements. The internal slope compensation for the adjustable and low-voltage fixed versions of the AAT2148 is 0.24A/ μ s. This equates to a slope compensation that is 75% of the inductor current down slope for a 1.5V output and 4.7 μ H inductor.

$$m = \frac{0.75 \cdot V_{O}}{L} = \frac{0.75 \cdot 1.5V}{4.7 \mu H} = 0.24 \frac{A}{\mu s}$$

This is the internal slope compensation for the adjustable (0.6V) version or low-voltage fixed versions. When externally programming the 0.6V version to 2.5V, the calculated inductance is $7.5\mu H$.

$$L = \frac{0.75 \cdot V_{o}}{m} = \frac{0.75 \cdot V_{o}}{0.24A \frac{A}{\mu s}} \approx 3 \frac{\mu s}{A} \cdot V_{o}$$

$$= 3\frac{\mu s}{A} \cdot 2.5V = 7.5\mu H$$

In this case, a standard 6.8µH value is selected.

For high-voltage fixed versions (≥ 2.5 V), m = 0.48A/ μ s. Table 1 displays inductor values for the AAT2148 fixed and adjustable options.

Manufacturer's specifications list both the inductor DC current rating, which is a thermal limitation, and the peak current rating, which is determined by the saturation characteristics. The inductor should not show any appreciable saturation under normal load conditions. Some inductors may meet the peak and average current ratings yet result in excessive losses due to a high DCR. Always consider the losses associated with the DCR and its effect on the total converter efficiency when selecting an inductor.

The $4.7\mu H$ SD3118 series inductor selected from Coilcraft has a $162m\Omega$ typical DCR and a 1.31A saturation current. At full load, the inductor DC loss is 162mW which gives a 9% loss in efficiency for a 1A, 1.8V output.

Input Capacitor

Select a 4.7µF to $10\mu F$ X7R or X5R ceramic capacitor for the input. To estimate the required input capacitor size, determine the acceptable input ripple level (V_{PP}) and solve for C. The calculated value varies with input voltage and is a maximum when V_{IN} is double the output voltage.

$$C_{IN} = \frac{\frac{V_O}{V_{IN}} \cdot \left(1 - \frac{V_O}{V_{IN}}\right)}{\left(\frac{V_{PP}}{I_O} - ESR\right) \cdot F_S}$$

$$\frac{V_O}{V_{IN}} \cdot \left(1 - \frac{V_O}{V_{IN}}\right) = \frac{1}{4} \text{ for } V_{IN} = 2 \cdot V_O$$

$$C_{IN(MIN)} = \frac{1}{\left(\frac{V_{PP}}{I_O} - ESR\right) \cdot 4 \cdot F_S}$$

Always examine the ceramic capacitor DC voltage coefficient characteristics when selecting the proper value. For example, the capacitance of a $10\mu F$, 6.3V, X5R ceramic capacitor with 5.0V DC applied is actually about $6\mu F$.

Output Voltage (V)	Inductor (µH)	Output Capacitor (µF)
1, 1.2	2.2	10
1.5, 1.8	4.7	4.7
2.5, 3.3	6.8	4.7

Table 1: Inductor and Output Capacitor Values.

The maximum input capacitor RMS current is:

$$I_{RMS} = I_{O} \cdot \sqrt{\frac{V_{O}}{V_{IN}} \cdot \left(1 - \frac{V_{O}}{V_{IN}}\right)}$$

The input capacitor RMS ripple current varies with the input and output voltage and will always be less than or equal to half of the total DC load current.

$$\sqrt{\frac{V_O}{V_{IN}} \cdot \left(1 - \frac{V_O}{V_{IN}}\right)} = \sqrt{D \cdot (1 - D)} = \sqrt{0.5^2} = \frac{1}{2}$$



Low Noise, Fast Transient IA Step-Down Converter

for $V_{IN} = 2 \cdot V_{O}$

$$I_{RMS(MAX)} = \frac{I_0}{2}$$

The term $\frac{V_o}{V_N} \cdot \left(1 \cdot \frac{V_o}{V_N}\right)$ appears in both the input voltage ripple and input capacitor RMS current equations and is a maximum when V_o is twice V_{IN} . This is why the input voltage ripple and the input capacitor RMS current ripple are a maximum at 50% duty cycle.

The input capacitor provides a low impedance loop for the edges of pulsed current drawn by the AAT2148. Low ESR/ESL X7R and X5R ceramic capacitors are ideal for this function. To minimize stray inductance, the capacitor should be placed as closely as possible to the IC. This keeps the high frequency content of the input current localized, minimizing EMI and input voltage ripple.

The proper placement of the input capacitor (C1) can be seen in the evaluation board layout in Figure 2.

A laboratory test set-up typically consists of two long wires running from the bench power supply to the evaluation board input voltage pins. The inductance of these wires, along with the low-ESR ceramic input capacitor, can create a high Q network that may affect converter performance. This problem often becomes apparent in the form of excessive ringing in the output voltage during load transients. Errors in the loop phase and gain measurements can also result.

Since the inductance of a short PCB trace feeding the input voltage is significantly lower than the power leads from the bench power supply, most applications do not exhibit this problem.

In applications where the input power source lead inductance cannot be reduced to a level that does not affect the converter performance, a high ESR tantalum or aluminum electrolytic should be placed in parallel with the low ESR, ESL bypass ceramic. This dampens the high Q network and stabilizes the system.

Output Capacitor

The output capacitor limits the output ripple and provides holdup during large load transitions. A 4.7 μ F to 10 μ F X5R or X7R ceramic capacitor typically provides sufficient bulk capacitance to stabilize the output during large load transitions and has the ESR and ESL characteristics necessary for low output ripple.

The output voltage droop due to a load transient is dominated by the capacitance of the ceramic output capacitor. During a step increase in load current, the ceramic output capacitor alone supplies the load current until the loop responds. Within two or three switching cycles, the loop responds and the inductor current increases to match the load current demand. The relationship of the output voltage droop during the three switching cycles to the output capacitance can be estimated by:

$$C_{OUT} = \frac{3 \cdot \Delta I_{LOAD}}{V_{DROOP} \cdot F_{S}}$$

Once the average inductor current increases to the DC load level, the output voltage recovers. The above equation establishes a limit on the minimum value for the output capacitor with respect to load transients.

The internal voltage loop compensation also limits the minimum output capacitor value to 4.7 μ F. This is due to its effect on the loop crossover frequency (bandwidth), phase margin, and gain margin. Increased output capacitance will reduce the crossover frequency with greater phase margin.

The maximum output capacitor RMS ripple current is given by:

$$I_{\text{RMS(MAX)}} = \frac{1}{2 \cdot \sqrt{3}} \cdot \frac{V_{\text{OUT}} \cdot (V_{\text{IN(MAX)}} - V_{\text{OUT}})}{L \cdot F \cdot V_{\text{IN(MAX)}}}$$

Dissipation due to the RMS current in the ceramic output capacitor ESR is typically minimal, resulting in less than a few degrees rise in hot-spot temperature.



Low Noise, Fast Transient 1A Step-Down Converter

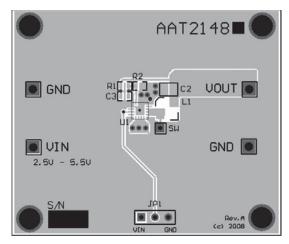


Figure 2: AAT2148 Evaluation Board Top Layer.

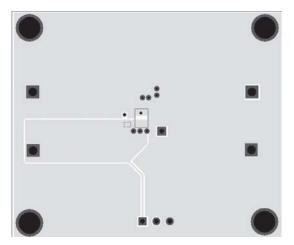


Figure 3: AAT2148 Evaluation Board Bottom Layer.

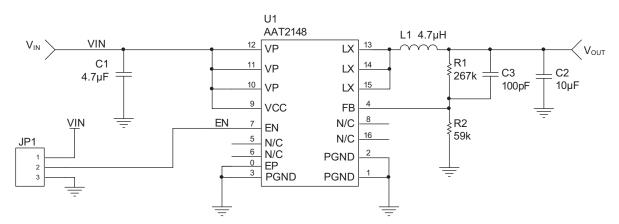


Figure 4: AAT2148 Evaluation Board Schematic.

Adjustable Output Resistor Selection

For applications requiring an adjustable output voltage, the 0.6V version can be externally programmed. Resistors R1 and R2 of Figure 4 program the output to regulate at a voltage higher than 0.6V. To limit the bias current required for the external feedback resistor string while maintaining good noise immunity, the minimum suggested value for R2 is $59k\Omega$. Although a larger value will further reduce quiescent current, it will also increase the impedance of the feedback node, making it more sensitive to external noise and interference. Table 2 summarizes the resistor values for various output voltages with

R2 set to either $59k\Omega$ for good noise immunity or $221k\Omega$ for reduced no load input current.

$$R3 = \left(\frac{V_{OUT}}{V_{REF}} - 1\right) \cdot R4 = \left(\frac{1.5V}{0.6V} - 1\right) \cdot 59k\Omega = 88.5k\Omega$$

The adjustable version of the AAT2148, combined with an external feedforward capacitor (C3 in Figure 1), delivers enhanced transient response for extreme pulsed load applications. The addition of the feedforward capacitor typically requires a larger output capacitor C2 for stability.



SwitchReg[™]

Low Noise, Fast Transient IA Step-Down Converter

	$R2 = 59k\Omega$	$R2 = 221k\Omega$
V _{out} (V)	R1 (k Ω)	R1 (Ω)
0.8	19.6	75K
0.9	29.4	113K
1.0	39.2	150K
1.1	49.9	187K
1.2	59.0	221K
1.3	68.1	261K
1.4	78.7	301K
1.5	88.7	332K
1.8	118	442K
1.85	124	464K
2.0	137	523K
2.5	187	715K
3.3	267	1.00M

Table 2: Adjustable Resistor Values For Use With 0.6V Step-Down Converter.

Thermal Calculations

There are three types of losses associated with the AAT2148 step-down converter: switching losses, conduction losses, and quiescent current losses. Conduction losses are associated with the $R_{\rm DS(ON)}$ characteristics of the power output switching devices. Switching losses are dominated by the gate charge of the power output switching devices. At full load, assuming continuous conduction mode (CCM), a simplified form of the losses is given by:

$$P_{TOTAL} = \frac{I_O^2 \cdot (R_{DSON(HS)} \cdot V_O + R_{DSON(LS)} \cdot [V_{IN} - V_O])}{V_{IN}}$$
$$+ (t_{sw} \cdot F \cdot I_O + I_O) \cdot V_{IN}$$

 I_{Q} is the step-down converter quiescent current. The term t_{sw} is used to estimate the full load step-down converter switching losses.

For the condition where the step-down converter is in dropout at 100% duty cycle, the total device dissipation reduces to:

$$P_{TOTAL} = I_O^2 \cdot R_{DSON(HS)} + I_Q \cdot V_{IN}$$

Since $R_{DS(ON)}$, quiescent current, and switching losses all vary with input voltage, the total losses should be investigated over the complete input voltage range.

Given the total losses, the maximum junction temperature can be derived from the θ_{JA} for the QFN33-16 package which is 50°C/W.

$$T_{J(MAX)} = P_{TOTAL} \cdot \Theta_{JA} + T_{AMB}$$

Layout

The suggested PCB layout for the AAT2148 is shown in Figures 2, 3, and 4. The following guidelines should be used to help ensure a proper layout.

- 1. The input capacitor (C1) should connect as closely as possible to V_{IN} (Pins 9-12) and PGND (Pins 1-3).
- 2. C2 and L1 should be connected as closely as possible. The connection of L1 to the LX pin should be as short as possible.
- 3. The feedback trace or FB pin (Pin 4) should be separate from any power trace and connect as closely as possible to the load point. Sensing along a high-current load trace will degrade DC load regulation. The external feedback resistors should be placed as closely as possible to the FB pin (Pin 4) to minimize the length of the high impedance feedback trace.
- 4. The resistance of the trace from the load return to PGND (Pins 1-3) should be kept to a minimum. This will help to minimize any error in DC regulation due to differences in the potential of the internal signal ground and the power ground.



Low Noise, Fast Transient IA Step-Down Converter

Step-Down Converter Design Example

Specifications

 $V_{\rm O}~=1.8V$ @ 1A (adjustable using 0.6V version), Pulsed Load $\Delta I_{\rm LOAD}=300 mA$

 $V_{IN} = 2.7V$ to 4.2V (3.6V nominal)

 $F_s = 2MHz$

 $T_{AMB} = 85$ °C

1.8V Output Inductor

L1 =
$$3\frac{\mu s}{A} \cdot V_{O1} = 3\frac{\mu s}{A} \cdot 1.8V = 5.4\mu H \text{ (use 4.7}\mu H; see Table 1)}$$

For Coilcraft inductor SD3118, 4.7 μ H, DCR = 162m Ω .

$$\Delta I_{L1} = \frac{V_O}{L1 \cdot F_S} \cdot 1 - \frac{V_O}{V_{IN}} = \frac{1.8V}{4.7 \mu H \cdot 2.0 MHz} \cdot \left(1 - \frac{1.8V}{4.2V}\right) = 109 mA$$

$$I_{PKL1} = I_{O} + \frac{\Delta I_{L1}}{2} = 1A + 0.055A = 1.055A$$

$$P_{1,1} = I_0^2 \cdot DCR = 1A^2 \cdot 162m\Omega = 162mW$$

1.8V Output Capacitor

$$V_{DROOP} = 0.1V$$

$$C_{\text{OUT}} = \frac{3 \cdot \Delta I_{\text{LOAD}}}{V_{\text{DROOP}} \cdot F_{\text{S}}} = \frac{3 \cdot 0.3 \text{A}}{0.1 \text{V} \cdot 2.0 \text{MHz}} = 4.5 \mu \text{F}; \text{ use } 4.7 \mu \text{F}$$

$$I_{\text{RMS}} = \frac{1}{2 \cdot \sqrt{3}} \cdot \frac{(V_{\text{O}}) \cdot (V_{\text{IN(MAX)}} - V_{\text{O}})}{\text{L1} \cdot \text{F} \cdot V_{\text{IN(MAX)}}} = \frac{1}{2 \cdot \sqrt{3}} \cdot \frac{1.8 \text{V} \cdot (4.2 \text{V} - 1.8 \text{V})}{4.7 \mu \text{H} \cdot 2.0 \text{MHz} \cdot 4.2 \text{V}} = 32 \text{mArms}$$

$$P_{esr} = esr \cdot I_{RMS}^2 = 5m\Omega \cdot (32mA)^2 = 6\mu W$$

Input Capacitor

Input Ripple $V_{PP} = 30mV$

$$C_{\text{IN}} = \frac{1}{\left(\frac{V_{\text{PP}}}{I_{\text{O}}} - \text{ESR}\right) \cdot 4 \cdot F_{\text{S}}} = \frac{1}{\left(\frac{30\text{mV}}{1\text{A}} - 5\text{mW}\right) \cdot 4 \cdot 2.0\text{MHz}} = 5\mu\text{F}; \text{ use } 4.7\mu\text{F}$$

$$I_{RMS} = \frac{I_O}{2} = 0.5 Arms$$

$$P = ESR \cdot I_{RMS}^2 = 5m\Omega \cdot (0.5A)^2 = 1.25mW$$



Low Noise, Fast Transient IA Step-Down Converter

AAT2148 Losses

$$\begin{split} P_{\text{TOTAL}} &= \frac{I_{\text{O}}^2 \cdot \left(R_{\text{DSON(HS)}} \cdot V_{\text{O}} + R_{\text{DSON(LS)}} \cdot [V_{\text{IN}} - V_{\text{O}}] \right)}{V_{\text{IN}}} \\ &+ \left(t_{\text{sw}} \cdot F \cdot I_{\text{O}} + I_{\text{Q}} \right) \cdot V_{\text{IN}} \end{split}$$

$$=\frac{1^2 \cdot (0.35\Omega \cdot 1.8V + 0.3\Omega \cdot [4.2V - 1.8V])}{4.2V}$$

+
$$(5ns \cdot 2.0MHz \cdot 1A + 70\mu A) \cdot 4.2V = 363mW$$

$$\mathsf{T}_{\mathsf{J}(\mathsf{MAX})} = \mathsf{T}_{\mathsf{AMB}} + \Theta_{\mathsf{JA}} \cdot \mathsf{P}_{\mathsf{LOSS}} = 85^{\circ}\mathsf{C} + (50^{\circ}\mathsf{C/W}) \cdot 363 \mathsf{mW} = 103.2^{\circ}\mathsf{C}$$



SwitchReg[™]

Low Noise, Fast Transient IA Step-Down Converter

Adjustable Version (0.6V device) V _{ουτ} (V)	R2 = 59kΩ R1 (kΩ)	$R2 = 221k\Omega^1$ $R1 (k\Omega)$	L1 (µH)
0.8	19.6	75.0	2.2
0.9	29.4	113	2.2
1.0	39.2	150	2.2
1.1	49.9	187	2.2
1.2	59.0	221	2.2
1.3	68.1	261	2.2
1.4	78.7	301	4.7
1.5	88.7	332	4.7
1.8	118	442	4.7
1.85	124	464	4.7
2.0	137	523	6.8
2.5	187	715	6.8
3.3	267	1000	6.8
Fixed Version V _{OUT} (V)		R4 Not Used R1 (kΩ)	L1 (µH)
0.6-3.3V		0	4.7

Table 3: Evaluation Board Component Values.

Manufacturer	Part Number	Inductance (µH)	Saturation Current (A)	DCR (Ω)	Size (mm) LxWxH	Туре
	CDRH3D16/HP-2R2	2.2	1.75	47	4.0x4.0x1.8	Shielded
Sumida	CDRH5D16-4R7	4.7	2.15	51.3	5.8x5.8x1.8	Shielded
	CDRH5D16-6R8	6.8	1.8	64.7	5.8x5.8x1.8	Shielded
	LQH3NPN2R2NG0	2.2	1.25	73	3.0x3.0x1.4	Shielded
Murata	LQH32PN2R2NN0	2.2	1.55	76	3.2x2.7x1.55	Shielded
	LQH32PN4R7NN0	4.7	1.0	180	3.2x2.7x1.55	Shielded
	SD3118-2R2-R	2.2	2.0	74	3.1x3.1x1.8	Shielded
Coilcraft	SD3118-4R7-R	4.7	1.31	162	3.1x3.1x1.8	Shielded
	SD3118-6R8-R	6.8	1.12	232	3.1x3.1x1.8	Shielded

Table 4: Typical Surface Mount Inductors.

Manufacturer	Part Number	Value	Voltage	Temp. Co.	Case
	GRM219R61A475KE19	4.7µF	10V	X5R	0805
Murata	GRM21BR60J106KE19	10μF	6.3V	X5R	0805
	GRM21BR60J226ME39	22μF	6.3V	X5R	0805

Table 5: Surface Mount Capacitors.

^{1.} For reduced quiescent current, R2 and R4 = $221k\Omega$.



Low Noise, Fast Transient IA Step-Down Converter

Ordering Information

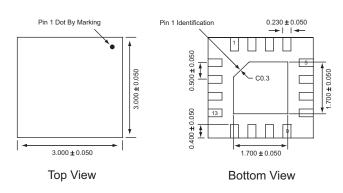
Output Voltage ¹	Package	Marking ²	Part Number (Tape and Reel) ³
Adj ≥ 0.6	QFN33-16	6VXYY	AAT2148IVN-0.6-T1

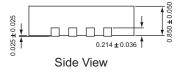


All AnalogicTech products are offered in Pb-free packaging. The term "Pb-free" means semiconductor products that are in compliance with current RoHS standards, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. For more information, please visit our website at http://www.analogictech.com/about/quality.aspx.

Package Information

QFN33-16





All dimensions in millimeters.

Advanced Analogic Technologies, Inc.

3230 Scott Boulevard, Santa Clara, CA 95054 Phone (408) 737-4600 Fax (408) 737-4611



© Advanced Analogic Technologies, Inc.

© Advanced Analogic Technologies, Inc.

AnalogicTech cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in an AnalogicTech product. No circuit patent licenses, copyrights, mask work rights, or other intellectual property rights are implied. AnalogicTech reserves the right to make changes to their products or specifications or to discontinue any product or service without notice. Except as provided in AnalogicTech's terms and conditions of sale, AnalogicTech assumes no liability whatsoever, and AnalogicTech disclaims any express or implied warranty relating to the sale and/or use of AnalogicTech products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards. Testing and other quality control techniques are utilized to the extent AnalogicTech deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed. AnalogicTech and the AnalogicTech logo are trademarks of Advanced Analogic Technologies Incorporated. All other brand and product names appearing in this document are registered trademarks or trademarks of their respective holders

^{1.} Contact Sales for other voltage options.

XYY = assembly and date code.

^{3.} Sample stock is typically held on part numbers listed in BOLD.